506619908 04/20/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6666715

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HOMARE SATO	09/18/2019

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716-9632

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17235761

CORRESPONDENCE DATA

Fax Number: (206)299-9288

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: IP.docket.SE@dorsey.com
Correspondent Name: DORSEY & WHITNEY LLP

Address Line 1: 701 FIFTH AVENUE

Address Line 2: SUITE 6100

Address Line 4: SEATTLE, WASHINGTON 98104

ATTORNEY DOCKET NUMBER:	P284295.US.02
NAME OF SUBMITTER:	JAMES DANIELSON
SIGNATURE:	/James Danielson/
DATE SIGNED:	04/20/2021

Total Attachments: 2

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PATENT 506619908 REEL: 055979 FRAME: 0863

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	
** •	Docket No. P284295.US.01
Homare Sato	
	Disclosure No. 2019-1186.00/US
Filed: Concurrently herewith	
For : SEMICONDUCTOR DEVICE	
PERFORMING IMPLICIT	
PRECHARGE OPERATION	

ASSIGNMENT:

_X	Enclosed for recording
	Previously recorded
Date:	
Reel:	

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned does hereby:

SELL, ASSIGN AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled "SEMICONDUCTOR DEVICE PERFORMING **IMPLICIT** PRECHARGE OPERATION"; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to

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others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Signature: Homare Sato	Date: 09/18/2019
Witness # 1: Signature: Harry Ni Saure Name: Masayoshi Yamazaki	Date: 09/13/2019
Witness # 2: Signature: Witness Name: Shoko Tomita	Date: 1 - 2 0 - 2 0 - 1